#### **DESCRIPTION**

The SPN3456 is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits, and low in-line power loss are needed in a very small outline surface mount package.

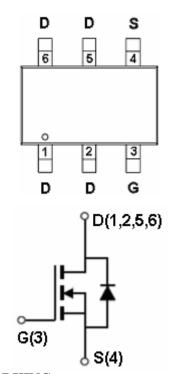
#### **APPLICATIONS**

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

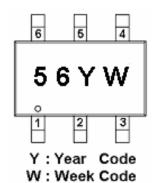
### **FEATURES**

- 30V/6.0A, RDS(ON)=  $40\Omega$ @VGS=10V
- 30V/5.0A, RDS(ON)=  $50\Omega$ @VGS=4.5V
- ◆ Super high density cell design for extremely low RDS (ON)
- Exceptional on-resistance and maximum DC current capability
- ◆ TSOP-6P package design

## PIN CONFIGURATION(TSOP-6P)



### **PART MARKING**



## **PIN DESCRIPTION**

Pin	Symbol	Description
1	D	Drain
2	D	Drain
3	G	Gate
4	S	Source
5	D	Drain
6	D	Drain

## **ORDERING INFORMATION**

Part Number	Package	Part Marking
SPN3456ST6RG	TSOP-6P	56YW

**%** Week Code :  $A \sim Z(1 \sim 26)$ ;  $a \sim z(27 \sim 52)$ 

※ SPN3456ST6RG: Tape Reel; Pb − Free

### **ABSOULTE MAXIMUM RATINGS**

(T<sub>A</sub>=25°C Unless otherwise noted)

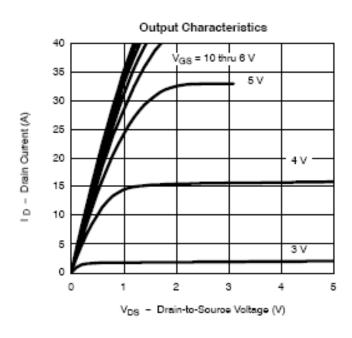
Parameter	Symbol	Typical	Unit	
Drain-Source Voltage	Vdss	30	V	
Gate –Source Voltage	VGSS	±20	V	
Continuous Drain Current(Tr-150°C)	TA=25°C	In	6.0	Δ.
Continuous Drain Current(TJ=150°€)	TA=70°C	- Id	5.0	A
Pulsed Drain Current	Iрм	30	A	
Continuous Source Current(Diode Conduct	Is	1.7	A	
Decree Dissipation	TA=25°C	D-	2.0	W
Power Dissipation	TA=70°C	PD	1.3	W
Operating Junction Temperature	Тл	150	°C	
Storage Temperature Range	Tstg	-55/150	°C	
Thermal Resistance-Junction to Ambient	RθJA	90	°C/W	

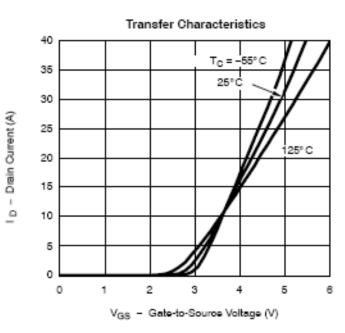
## **ELECTRICAL CHARACTERISTICS**

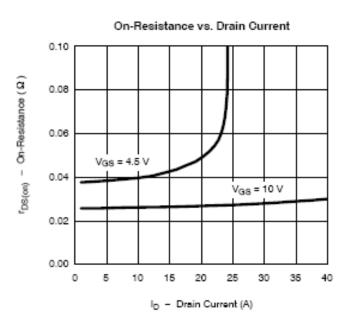
(TA=25°C Unless otherwise noted)

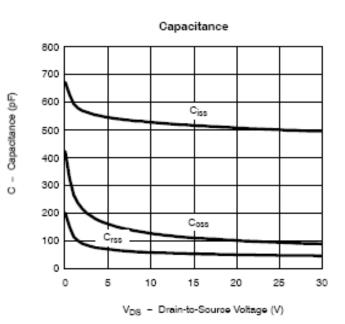
Parameter	Symbol	Conditions	Min.	Тур	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V(BR)DSS	V <sub>G</sub> S=0V,I <sub>D</sub> =250uA	30			V	
Gate Threshold Voltage	VGS(th)	VDS=VGS,ID=250uA	1.0		3.0	· •	
Gate Leakage Current	Igss	V <sub>DS</sub> =0V,V <sub>GS</sub> =±20V			±100	nA	
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =24V,V <sub>GS</sub> =1.0V V <sub>DS</sub> =24V,V <sub>GS</sub> =0.0V T <sub>J</sub> =55°C	V <sub>DS</sub> =24V,V <sub>GS</sub> =1.0V V <sub>DS</sub> =24V,V <sub>GS</sub> =0.0V		1 10	uA	
On-State Drain Current	ID(on)	V <sub>DS</sub> ≥ 4.5 V, V <sub>GS</sub> =4.5 V	10			A	
Drain-Source On-Resistance	RDS(on)	V <sub>GS</sub> = 10V,I <sub>D</sub> =6.0A V <sub>GS</sub> =4.5V,I <sub>D</sub> =5.0A		0.030 0.040	0.040 0.050	Ω	
Forward Transconductance	gfs	VDS=4.5V,ID=5.4A		12		S	
Diode Forward Voltage	Vsd	Is=1.7A,VGS=0V		0.8	1.2	V	
Dynamic							
Total Gate Charge	Qg			10	18		
Gate-Source Charge	Qgs	V <sub>DS</sub> =15V <sub>GS</sub> =10V I <sub>D</sub> =6.7A		1.6		nC	
Gate-Drain Charge	Qgd	-10-0.711		3.2			
Input Capacitance	Ciss			450			
Output Capacitance	Coss	V <sub>DS</sub> =15V <sub>GS</sub> =0V f=1MHz		240		pF	
Reverse Transfer Capacitance	Crss			38			
T. O. T.	td(on)			7	15	ns	
Turn-On Time	tr	V <sub>DD</sub> =15RL=15		10	20		
T Off Time	td(off)	-ID≡1.0A,VGEN=10 RG=6Ω		20	40		
Turn-Off Time	tf	]		11	20	] <b>[</b>	

### TYPICAL CHARACTERISTICS

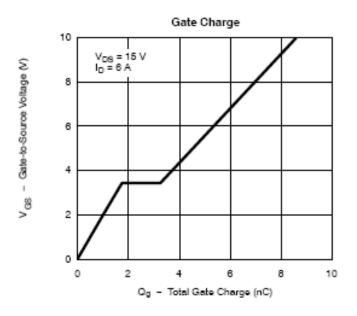


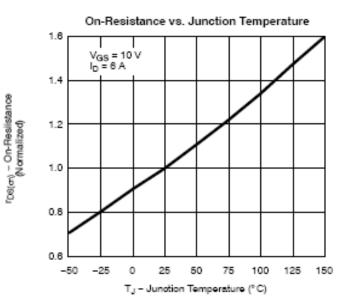


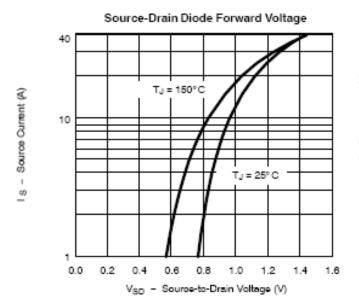


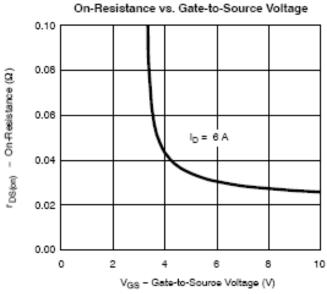


#### TYPICAL CHARACTERISTICS

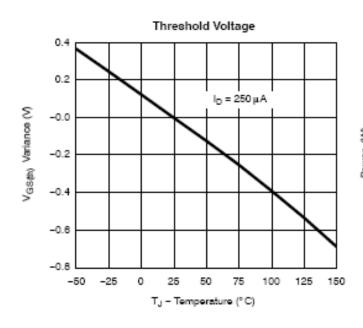


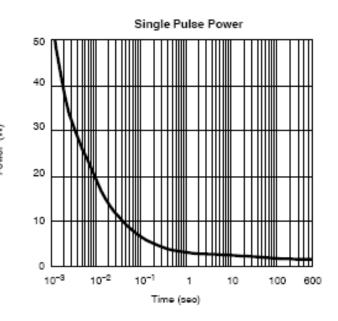




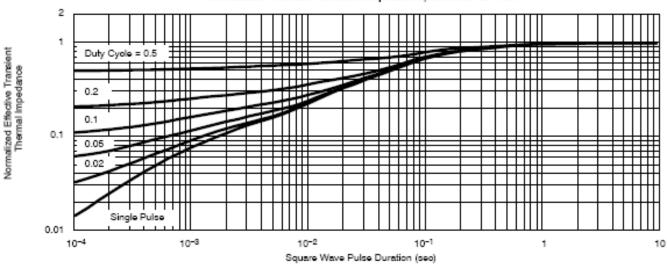


## TYPICAL CHARACTERISTICS



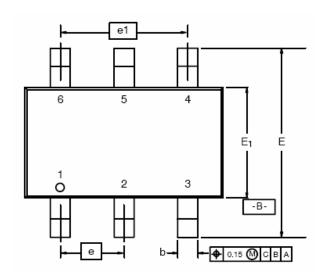


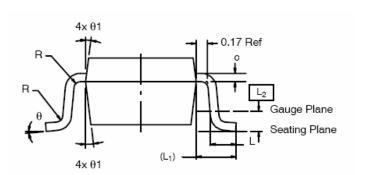






# TSOP- 6P PACKAGE OUTLINE





	MILLIMETERS			INCHES		
Dim	Min	Nom	Max	Min	Nom	Max
Α	0.91	-	1.10	0.036	-	0.043
Α1	0.01	-	0.10	0.0004	-	0.004
A <sub>2</sub>	0.90	-	1.00	0.035	0.038	0.039
b	0.30	0.32	0.45	0.012	0.013	0.018
c	0.10	0.15	0.20	0.004	0.006	0.008
D	2.95	3.05	3.10	0.116	0.120	0.122
E	2.70	2.85	2.98	0.108	0.112	0.117
E <sub>1</sub>	1.55	1.65	1.70	0.061	0.065	0.067
e		1.00 BSC		0.0394 BSC		
e <sub>1</sub>	1.90	2.00	2.10	0.075	0.080	0.085
Г	0.35	-	0.50	0.014	-	0.020
L <sub>1</sub>		0.60 Ref 0.024 Ref				
L <sub>2</sub>	0.25 BSC		0.010 BSC			
R	0.10	-	-	0.004	-	-
θ	0°	4*	8°	0"	4*	8"
θ1	7° Nom			7° Nom		

Information provided is alleged to be exact and consistent. SYNC Power Corporation presumes no responsibility for the penalties of use of such information or for any violation of patents or other rights of third parties which may result from its use. No license is granted by allegation or otherwise under any patent or patent rights of SYNC Power Corporation. Conditions mentioned in this publication are subject to change without notice. This publication surpasses and replaces all information previously supplied. SYNC Power Corporation products are not authorized for use as critical components in life support devices or systems without express written approval of SYNC Power Corporation.

©The SYNC Power logo is a registered trademark of SYNC Power Corporation
©2004 SYNC Power Corporation – Printed in Taiwan – All Rights Reserved
SYNC Power Corporation
9F-5, No.3-2, Park Street
NanKang District (NKSP), Taipei, Taiwan, 115, R.O.C
Phone: 886-2-2655-8178

Fax: 886-2-2655-8468 ©http://www.syncpower.com